

DATA SHEET

74LVC1G18

1-of-2 non-inverting demultiplexer
with 3-state deselected output

Product specification

2003 Jul 25

1-of-2 non-inverting demultiplexer with 3-state deselected output

74LVC1G18

FEATURES

- Wide supply voltage range from 1.65 to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 to 1.95 V)
 - JESD8-5 (2.3 to 2.7 V)
 - JESD8B/JESD36 (2.7 to 3.6 V).
- ESD protection:
 - HBM EIA/JESD22-A114-A exceeds 2000 V
 - MM EIA/JESD22-A115-A exceeds 200 V.
- ± 24 mA output drive ($V_{CC} = 3.0$ V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- SOT363 and SOT457 package
- Specified from -40 to $+85$ °C and -40 to $+125$ °C.

DESCRIPTION

The 74LVC1G18 is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

Input can be driven from either 3.3 or 5 V devices. These features allow the use of these devices in a mixed 3.3 and 5 V environment.

This device is fully specified for partial power-down applications using I_{off} . The I_{off} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74LVC1G18 is a 1-of-2 non-inverting demultiplexer with a 3-state output. The 74LVC1G18 buffers the data on input pin A and passes it either to output 1Y or 2Y, depending on whether the state of the select input (pin S) is LOW or HIGH.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25$ °C.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	propagation delay input A to output nY	$V_{CC} = 1.8$ V; $C_L = 30$ pF; $R_L = 1$ k Ω	5.1	ns
		$V_{CC} = 2.5$ V; $C_L = 30$ pF; $R_L = 500$ Ω	3.2	ns
		$V_{CC} = 2.7$ V; $C_L = 50$ pF; $R_L = 500$ Ω	3.2	ns
		$V_{CC} = 3.3$ V; $C_L = 50$ pF; $R_L = 500$ Ω	3.0	ns
		$V_{CC} = 5.0$ V; $C_L = 50$ pF; $R_L = 500$ Ω	2.3	ns
C_I	input capacitance		2.5	pF
C_{PD}	power dissipation capacitance per gate	$V_{CC} = 3.3$ V; notes 1 and 2	28.8	pF

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = total load switching outputs;

$\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

2. The condition is $V_I = \text{GND to } V_{CC}$.

1-of-2 non-inverting demultiplexer with
3-state deselected output

74LVC1G18

FUNCTION TABLE

See note 1.

INPUT		OUTPUT	
S	A	1Y	2Y
L	L	L	Z
L	H	H	Z
H	L	Z	L
H	H	Z	H

Note

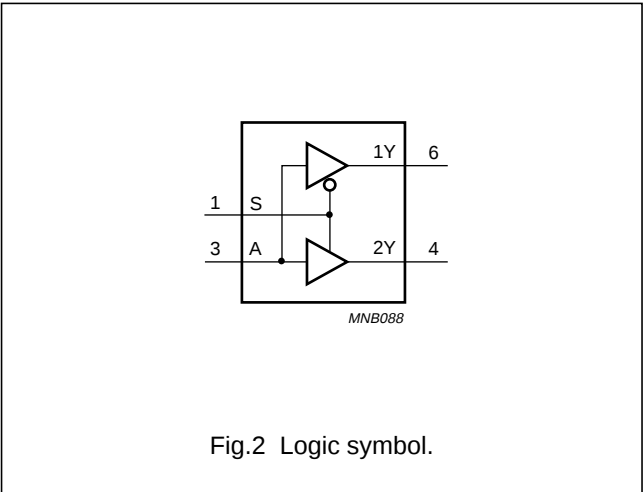
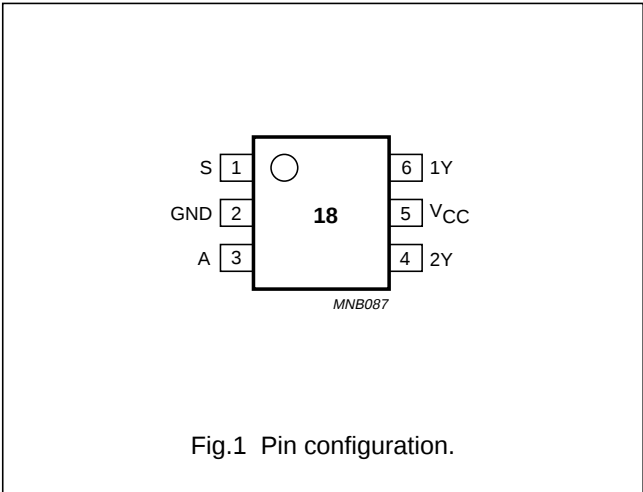
1. H = HIGH voltage level;
L = LOW voltage level;
Z = high-impedance OFF-state.

ORDERING INFORMATION

TYPE NUMBER	PACKAGE					
	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE	MARKING
74LVC1G18GW	−40 to +125 °C	6	SC-88	plastic	SOT363	VW
74LVC1G18GV	−40 to +125 °C	6	SC-74	plastic	SOT457	V18

PINNING

PIN	SYMBOL	DESCRIPTION
1	S	data select
2	GND	ground (0 V)
3	A	data input
4	2Y	data output
5	V _{CC}	supply voltage
6	1Y	data output



1-of-2 non-inverting demultiplexer with 3-state deselected output

74LVC1G18

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CC}	supply voltage		1.65	5.5	V
V_I	input voltage		0	5.5	V
V_O	output voltage	active mode	0	V_{CC}	V
		$V_{CC} = 0$ V; Power-down or high-impedance state	0	5.5	V
T_{amb}	operating ambient temperature		-40	+125	°C
t_r, t_f	input rise and fall times	$V_{CC} = 1.65$ to 2.7 V	0	20	ns/V
		$V_{CC} = 2.7$ to 5.5 V	0	10	ns/V

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CC}	supply voltage		-0.5	+6.5	V
I_{IK}	input diode current	$V_I < 0$	-	-50	mA
V_I	input voltage	note 1	-0.5	+6.5	V
I_{OK}	output diode current	$V_O > V_{CC}$ or $V_O < 0$	-	±50	mA
V_O	output voltage	active mode; notes 1 and 2	-0.5	$V_{CC} + 0.5$	V
		Power-down mode; notes 1 and 2	-0.5	+6.5	V
I_O	output source or sink current	$V_O = 0$ to V_{CC}	-	±50	mA
I_{CC}, I_{GND}	V_{CC} or GND current		-	±100	mA
T_{stg}	storage temperature		-65	+150	°C
P_D	power dissipation	$T_{amb} = -40$ to $+125$ °C	-	300	mW

Notes

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. When $V_{CC} = 0$ V (Power-down mode), the output voltage can be 5.5 V in normal operation.

1-of-2 non-inverting demultiplexer with 3-state deselected output

74LVC1G18

DC CHARACTERISTICS

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V _{CC} (V)				
T _{amb} = −40 to +85 °C; note 1							
V _{IH}	HIGH-level input voltage		1.65 to 1.95	0.65 × V _{CC}	—	—	V
			2.3 to 2.7	1.7	—	—	V
			2.7 to 3.6	2.0	—	—	V
			4.5 to 5.5	0.7 × V _{CC}	—	—	V
V _{IL}	LOW-level input voltage		1.65 to 1.95	—	—	0.35 × V _{CC}	V
			2.3 to 2.7	—	—	0.7	V
			2.7 to 3.6	—	—	0.8	V
			4.5 to 5.5	—	—	0.3 × V _{CC}	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}					
		I _O = 100 μA	1.65 to 5.5	—	—	0.1	V
		I _O = 4 mA	1.65	—	—	0.45	V
		I _O = 8 mA	2.3	—	—	0.3	V
		I _O = 12 mA	2.7	—	—	0.4	V
		I _O = 24 mA	3.0	—	—	0.55	V
		I _O = 32 mA	4.5	—	—	0.55	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}					
		I _O = −100 μA	1.65 to 5.5	V _{CC} − 0.1	—	—	V
		I _O = −4 mA	1.65	1.2	—	—	V
		I _O = −8 mA	2.3	1.9	—	—	V
		I _O = −12 mA	2.7	2.2	—	—	V
		I _O = −24 mA	3.0	2.3	—	—	V
		I _O = −32 mA	4.5	3.8	—	—	V
I _{LI}	input leakage current	V _I = 5.5 V or GND	5.5	—	±0.1	±5	μA
I _{OZ}	3-state output OFF-state current	V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND	5.5	—	±0.1	±10	μA
I _{off}	power OFF leakage current	V _I or V _O = 5.5 V	0	—	±0.1	±10	μA
I _{CC}	quiescent supply current	V _I = V _{CC} or GND; I _O = 0	5.5	—	0.1	10	μA
ΔI _{CC}	additional quiescent supply current per pin	V _I = V _{CC} − 0.6 V; I _O = 0	2.3 to 5.5	—	5	500	μA

1-of-2 non-inverting demultiplexer with 3-state deselected output

74LVC1G18

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V _{CC} (V)				
T _{amb} = −40 to +125 °C							
V _{IH}	HIGH-level input voltage		1.65 to 1.95	0.65 × V _{CC}	−	−	V
			2.3 to 2.7	1.7	−	−	V
			2.7 to 3.6	2.0	−	−	V
			4.5 to 5.5	0.7 × V _{CC}	−	−	V
V _{IL}	LOW-level input voltage		1.65 to 1.95	−	−	0.35 × V _{CC}	V
			2.3 to 2.7	−	−	0.7	V
			2.7 to 3.6	−	−	0.8	V
			4.5 to 5.5	−	−	0.3 × V _{CC}	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}					
		I _O = 100 μA	1.65 to 5.5	−	−	0.1	V
		I _O = 4 mA	1.65	−	−	0.70	V
		I _O = 8 mA	2.3	−	−	0.45	V
		I _O = 12 mA	2.7	−	−	0.60	V
		I _O = 24 mA	3.0	−	−	0.80	V
		I _O = 32 mA	4.5	−	−	0.80	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}					
		I _O = −100 μA	1.65 to 5.5	V _{CC} − 0.1	−	−	V
		I _O = −4 mA	1.65	0.95	−	−	V
		I _O = −8 mA	2.3	1.7	−	−	V
		I _O = −12 mA	2.7	1.9	−	−	V
		I _O = −24 mA	3.0	2.0	−	−	V
		I _O = −32 mA	4.5	3.4	−	−	V
I _{LI}	input leakage current	V _I = 5.5 V or GND	5.5	−	−	±20	μA
I _{OZ}	3-state output OFF-state current	V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND	5.5	−	−	±20	μA
I _{off}	power OFF leakage current	V _I or V _O = 5.5 V	0	−	−	±20	μA
I _{CC}	quiescent supply current	V _I = V _{CC} or GND; I _O = 0	5.5	−	−	40	μA
ΔI _{CC}	additional quiescent supply current per pin	V _I = V _{CC} − 0.6 V; I _O = 0	2.3 to 5.5	−	−	5000	μA

Note

1. All typical values are measured at $V_{CC} = 3.3 \text{ V}$ and $T_{amb} = 25$ °C.

1-of-2 non-inverting demultiplexer with 3-state deselected output

74LVC1G18

AC CHARACTERISTICS

GND = 0 V.

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V _{CC} (V)				
T _{amb} = −40 to +85 °C; note 1							
t _{PHL} /t _{PLH}	propagation delay input A to output nY	see Figs 3 and 5	1.65 to 1.95	1.0	5.1	10.0	ns
			2.3 to 2.7	1.0	3.2	5.5	ns
			2.7	1.0	3.2	5.4	ns
			3.0 to 3.6	1.0	3.0	5.0	ns
			4.5 to 5.5	1.0	2.3	3.8	ns
t _{PZH} /t _{PZL}	3-state output enable time input S to output nY	see Figs 4 and 5	1.65 to 1.95	1.0	5.8	11.0	ns
			2.3 to 2.7	1.0	3.6	6.2	ns
			2.7	1.0	3.6	6.0	ns
			3.0 to 3.6	1.0	3.1	5.2	ns
			4.5 to 5.5	1.0	2.4	3.6	ns
t _{PHZ} /t _{PLZ}	3-state output disable time input S to output nY	see Figs 4 and 5	1.65 to 1.95	1.0	4.8	9.0	ns
			2.3 to 2.7	1.0	2.7	5.3	ns
			2.7	1.0	3.5	5.2	ns
			3.0 to 3.6	1.0	3.3	4.9	ns
			4.5 to 5.5	0.5	2.2	3.3	ns
T _{amb} = −40 to +125 °C							
t _{PHL} /t _{PLH}	propagation delay input A to output nY	see Figs 3 and 5	1.65 to 1.95	1.0	–	12.5	ns
			2.3 to 2.7	0.5	–	6.9	ns
			2.7	0.5	–	6.8	ns
			3.0 to 3.6	0.5	–	6.3	ns
			4.5 to 5.5	0.5	–	4.8	ns
t _{PZH} /t _{PZL}	3-state output enable time input S to output nY	see Figs 4 and 5	1.65 to 1.95	1.0	–	13.8	ns
			2.3 to 2.7	0.5	–	7.8	ns
			2.7	0.5	–	7.5	ns
			3.0 to 3.6	0.5	–	6.5	ns
			4.5 to 5.5	0.5	–	4.5	ns
t _{PHZ} /t _{PLZ}	3-state output disable time input S to output nY	see Figs 4 and 5	1.65 to 1.95	1.0	–	11.3	ns
			2.3 to 2.7	0.5	–	6.6	ns
			2.7	0.5	–	6.5	ns
			3.0 to 3.6	0.5	–	6.1	ns
			4.5 to 5.5	0.5	–	4.1	ns

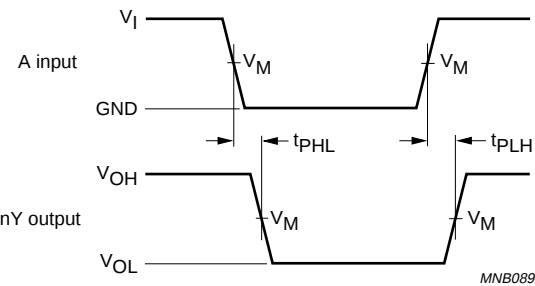
Note

1. All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

1-of-2 non-inverting demultiplexer with
3-state deselected output

74LVC1G18

AC WAVEFORMS



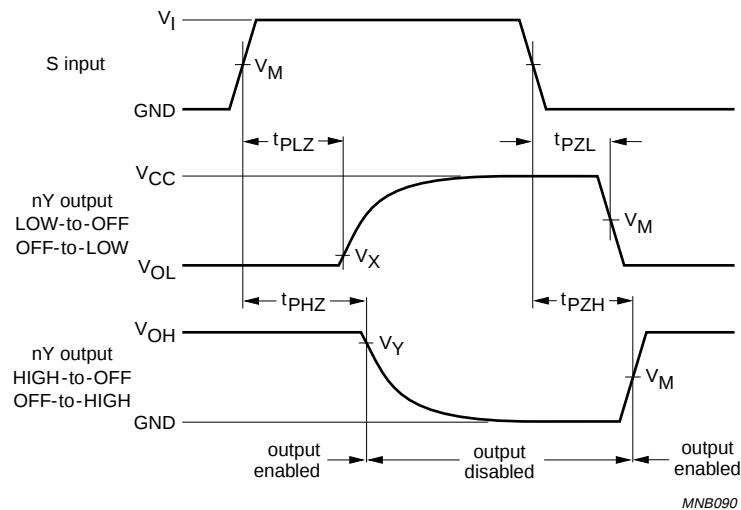
V_{CC}	V_M	INPUT	
		V_I	$t_r = t_f$
1.65 to 1.95 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.0 ns
2.3 to 2.7 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.0 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns
4.5 to 5.5 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns

V_{OL} and V_{OH} are typical output voltage drop that occur with the output load.

Fig.3 Input A to output nY propagation delays.

1-of-2 non-inverting demultiplexer with
3-state deselected output

74LVC1G18



V_{CC}	V_M	INPUT	
		V_I	$t_r = t_f$
1.65 to 1.95 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.0 ns
2.3 to 2.7 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.0 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns
4.5 to 5.5 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns

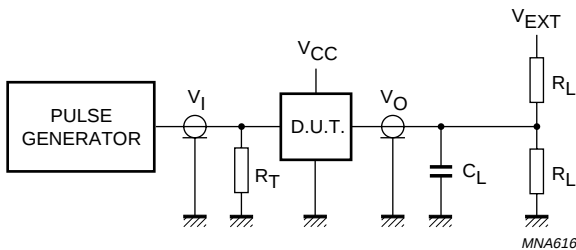
$V_X = V_{OL} + 0.3$ V at $V_{CC} \geq 2.7$ V;
 $V_X = V_{OL} + 0.15$ V at $V_{CC} < 2.7$ V;
 $V_Y = V_{OH} - 0.3$ V at $V_{CC} \geq 2.7$ V;
 $V_Y = V_{OH} - 0.15$ V at $V_{CC} < 2.7$ V.

V_{OL} and V_{OH} are typical output voltage drop that occur with the output load.

Fig.4 3-state enable and disable times S to nY.

1-of-2 non-inverting demultiplexer with
3-state deselected output

74LVC1G18



V _{CC}	V _I	C _L	R _L	V _{EXT}		
				t _{PLH} /t _{PHL}	t _{PZH} /t _{PHZ}	t _{PZL} /t _{PLZ}
1.65 to 1.95 V	V _{CC}	30 pF	1 kΩ	open	GND	2 × V _{CC}
2.3 to 2.7 V	V _{CC}	30 pF	500 Ω	open	GND	2 × V _{CC}
2.7 V	2.7 V	50 pF	500 Ω	open	GND	6 V
3.0 to 3.6 V	2.7 V	50 pF	500 Ω	open	GND	6 V
4.5 to 5.5 V	V _{CC}	50 pF	500 Ω	open	GND	2 × V _{CC}

Definitions for test circuit:
R_L = Load resistor.
C_L = Load capacitance including jig and probe capacitance.
R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

Fig.5 Load circuitry for switching times.

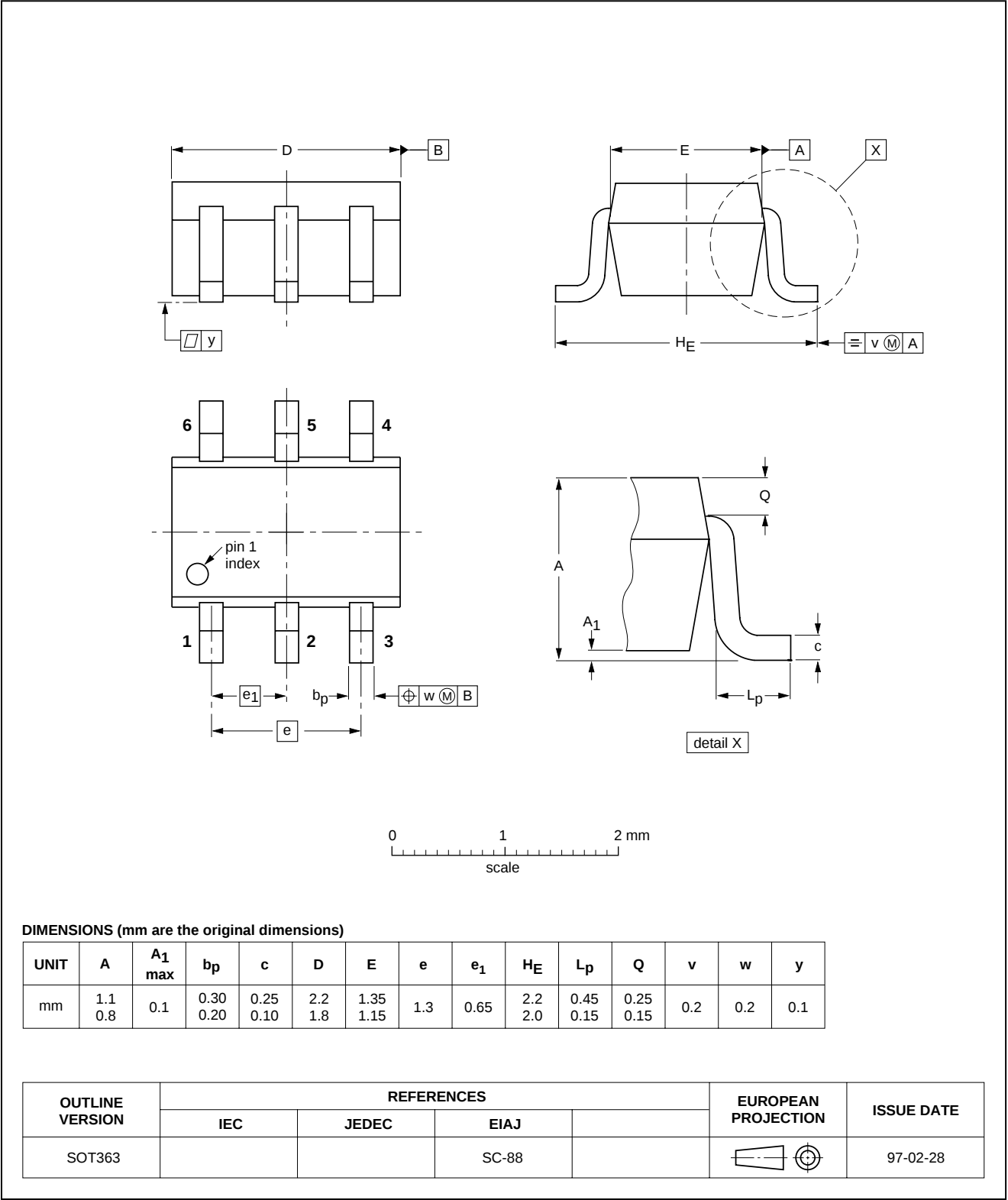
1-of-2 non-inverting demultiplexer with
3-state deselected output

74LVC1G18

PACKAGE OUTLINES

Plastic surface mounted package; 6 leads

SOT363

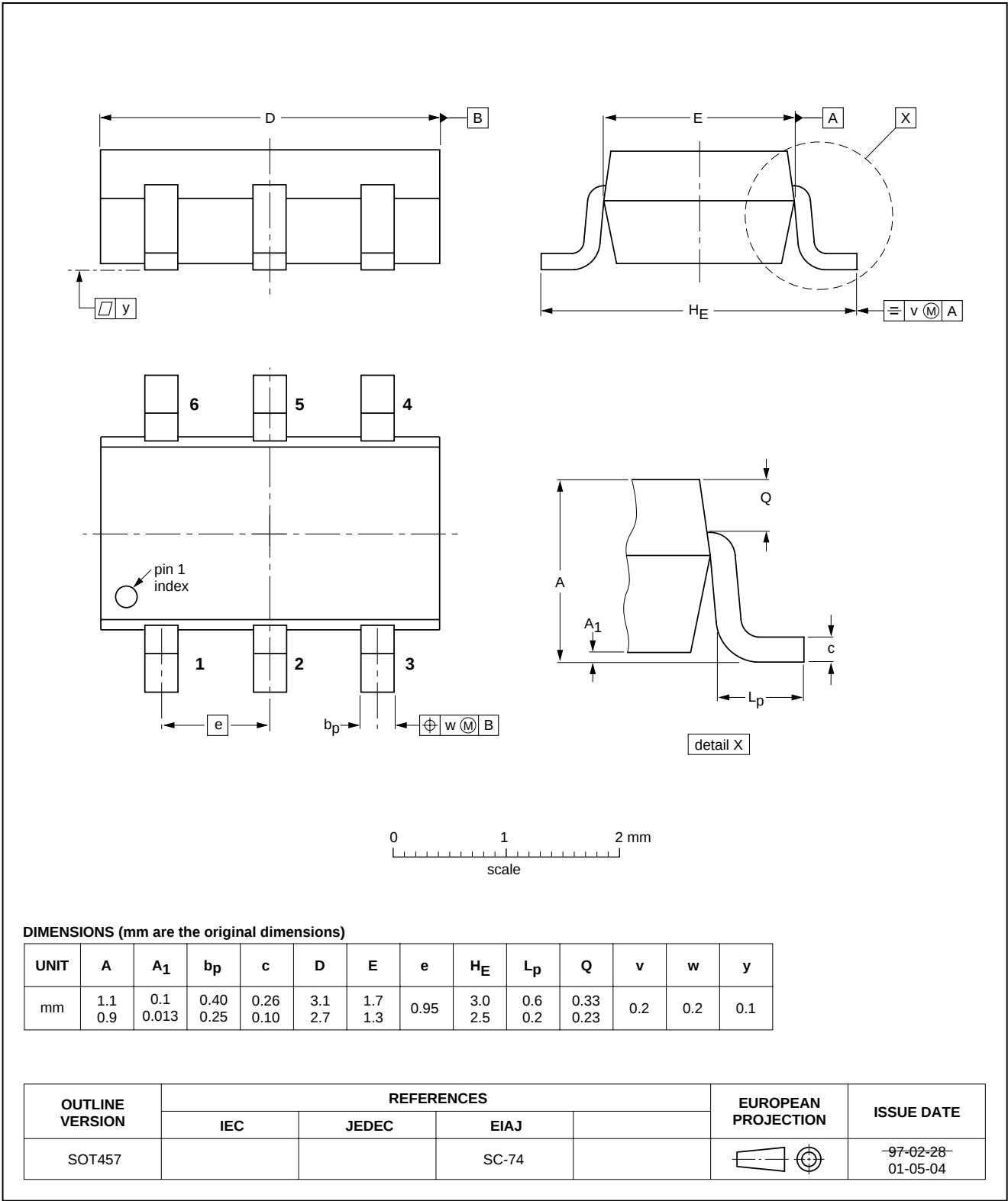


1-of-2 non-inverting demultiplexer with
3-state deselected output

74LVC1G18

Plastic surface mounted package; 6 leads

SOT457



1-of-2 non-inverting demultiplexer with 3-state deselected output

74LVC1G18

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

1. Please consult the most recently issued data sheet before initiating or completing a design.
2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.
3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

DISCLAIMERS

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products - including circuits, standard cells, and/or software - described or contained herein in order to improve design and/or performance. When the product is in full production (status 'Production'), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors – a worldwide company

Contact information

For additional information please visit **<http://www.semiconductors.philips.com>**. Fax: **+31 40 27 24825**

For sales offices addresses send e-mail to: **sales.addresses@www.semiconductors.philips.com**.

© Koninklijke Philips Electronics N.V. 2003

SCA75

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

613508/01/pp14

Date of release: 2003 Jul 25

Document order number: 9397 750 11667

Let's make things better.

**Philips
Semiconductors**



PHILIPS